

N and P-Channel Enhancement Mode Power MOSFET

Description

The NCE30NP07S uses advanced trench technology to provide excellent $R_{DS(ON)}$ and low gate charge . The complementary MOSFETs may be used to form a level shifted high side switch, and for a host of other applications.

General Features

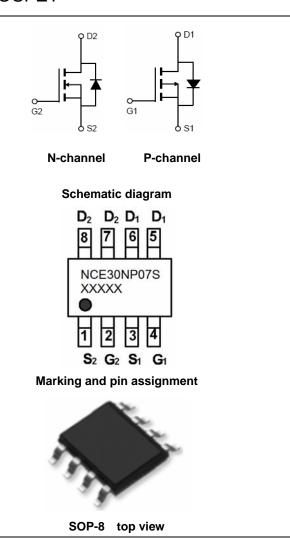
N-Channel

- V_{DS} = 30V, I_{D} =6.5A
- $R_{DS(ON)} < 24m\Omega @ V_{GS} = 10V$
- $R_{DS(ON)}$ < 37m Ω @ V_{GS}=4.5V

P-Channel

$$\begin{split} V_{DS} &= -30 V, I_D = -7 A \\ R_{DS(ON)} &< 32 m \Omega @ V_{GS} = -10 V \\ R_{DS(ON)} &< 70 m \Omega @ V_{GS} = -4.5 V \end{split}$$

- High power and current handing capability
- Lead free product is acquired
- Surface mount package



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity	
NCE30NP07S	NCE30NP07S	SOP-8	Ø330mm	12mm	4000 units	
Ab a shife Manimum Dation on $(T = 0.5\%)$ we have a the multiple matrix $(T = 0.5\%)$						

Absolute Maximum Ratings (T_A=25[°]C unless otherwise noted)

Parame	Symbol	N-Channel	P-Channel	Unit		
Drain-Source Voltage		V _{DS}	30	-30	V	
Gate-Source Voltage		V _{GS}	±20	±20	V	
Continuous Drain Current	T _A =25℃		6.5	-7	A	
	T _A =70℃	I _D	5.4	-5.8		
Pulsed Drain Current (Note 1)		I _{DM}	30	-30	А	
Maximum Power Dissipation T _A =25 °C		PD	2.0	2.0	W	
Operating Junction and Storage 1	T _J ,T _{STG}	-55 To 150	-55 To 150	°C		
Thermal Characteristic						
Thermal Resistance, Junction-to-A	R _{0JA}	N-Ch	62.5	°C /W		
Thermal Resistance, Junction-to-A	R _{θJA}	P-Ch	62.5	°C /W		



N-CH Electrical Characteristics (T_A=25[°]C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	30	33	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =30V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V_{GS} =±20V, V_{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)	·					
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	1	1.6	3	V
Drain-Source On-State Resistance	D	V_{GS} =10V, I _D =6A	-	19	24	mΩ
Drain-Source On-State Resistance	R _{DS(ON)}	V_{GS} =4.5V, I_{D} =6A	-	26	37	mΩ
Forward Transconductance	g fs	V _{DS} =5V,I _D =6A	15	-	-	S
Dynamic Characteristics (Note4)	·					
Input Capacitance	C _{lss}	(-15)()(-0)(-	485.8	-	PF
Output Capacitance	Coss	V _{DS} =15V,V _{GS} =0V, F=1.0MHz	-	65.2	-	PF
Reverse Transfer Capacitance	C _{rss}		-	54	-	PF
Switching Characteristics (Note 4)	·					
Turn-on Delay Time	t _{d(on)}		-	4.0	-	nS
Turn-on Rise Time	tr	V_{DD} =15V, R _L =2.5 Ω	-	2.0	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10V, R_{GEN} =3 Ω	-	14.0	-	nS
Turn-Off Fall Time	t _f		-	3.0	-	nS
Total Gate Charge	Qg		-	12.6	-	nC
Gate-Source Charge	Q _{gs}	V_{DS} =15V,I _D =6A,	-	1.9	-	nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	2.6	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =6A	-	0.8	1.2	V



P-CH Electrical Characteristics (T_A=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
rain-Source Breakdown Voltage BV _{DSS} V _{GS}		V _{GS} =0V I _D =-250µA	-30	-33	-	V
Zero Gate Voltage Drain Current	I _{DSS}	I _{DSS} V _{DS} =-30V,V _{GS} =0V		-	-1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V		-	±100	nA
On Characteristics (Note 3)	····			•		
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=-250\mu A$	-1.3	-1.65	-2.5	V
Drain Course On State Desistance	D	V _{GS} =-10V, I _D =-6.5A	-	28	32	mΩ
Drain-Source On-State Resistance	R _{DS(ON)}	V_{GS} =-4.5V, I _D =-6.5A	-	49	70	mΩ
Forward Transconductance	g fs	V _{DS} =-5V,I _D =-6.5A	10	-	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C _{lss}		-	691.9	-	PF
Output Capacitance	C _{oss}	V _{DS} =-15V,V _{GS} =0V, F=1.0MHz	-	113.7	-	PF
Reverse Transfer Capacitance	C _{rss}		-	109.4	-	PF
Switching Characteristics (Note 4)			-			
Turn-on Delay Time	t _{d(on)}		-	7.5	-	nS
Turn-on Rise Time	tr	V_{DD} =-15V, R _L =2.3 Ω	-	5.5	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =-10V, R_{GEN} =6 Ω	-	19	-	nS
Turn-Off Fall Time	t _f		-	7	-	nS
Total Gate Charge	Qg		-	16.3	-	nC
Gate-Source Charge	Q _{gs}	V _{DS} =-15V,I _D =-6.5A V _{GS} =-10V	-	2.2	-	nC
Gate-Drain Charge	Q _{gd}	VGS10V	-	4.1	-	nC
Drain-Source Diode Characteristics						•
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =-6.5A	-	-	-1.2	V

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

2. Surface Mounted on FR4 Board, $t \le 10$ sec.

3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.

4. Guaranteed by design, not subject to production



N- Channel Typical Electrical and Thermal Characteristics (Curves)

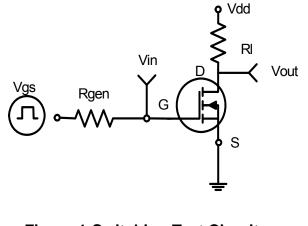
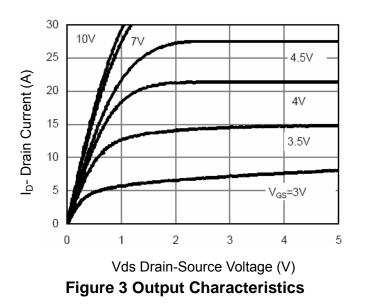
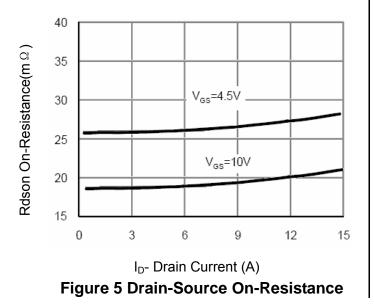
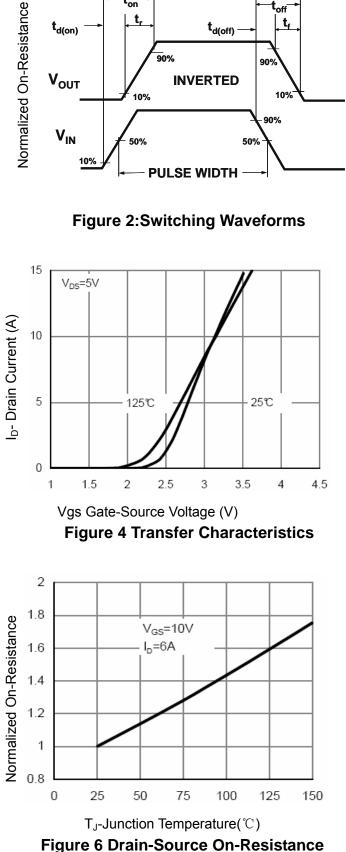


Figure 1:Switching Test Circuit



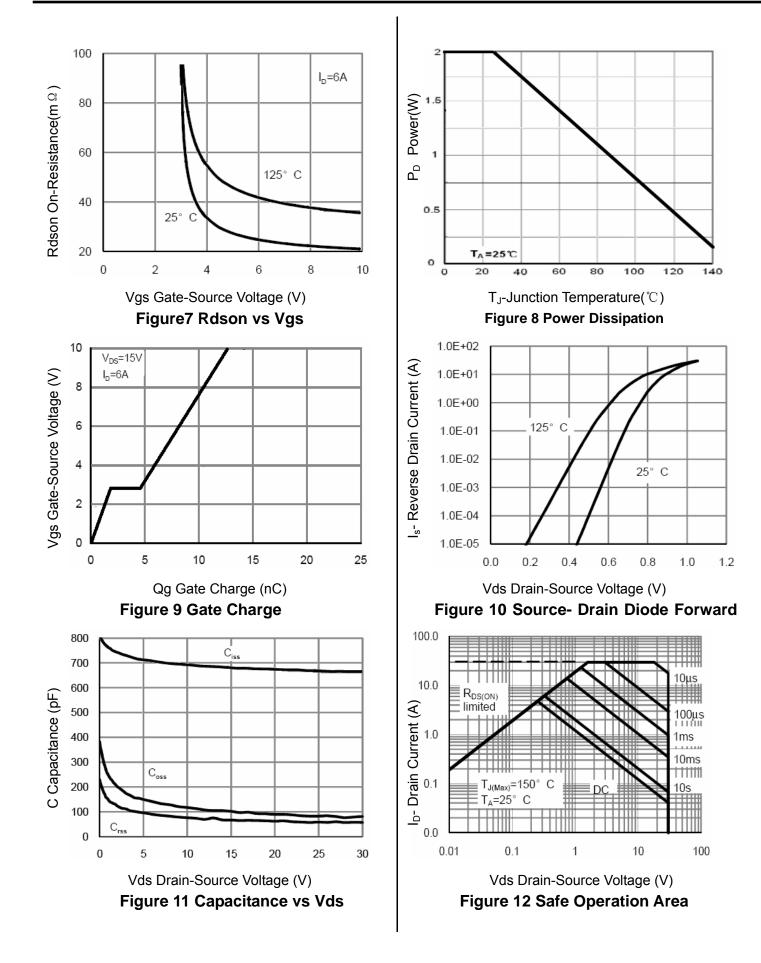






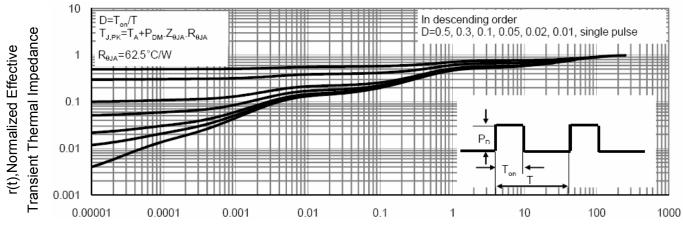
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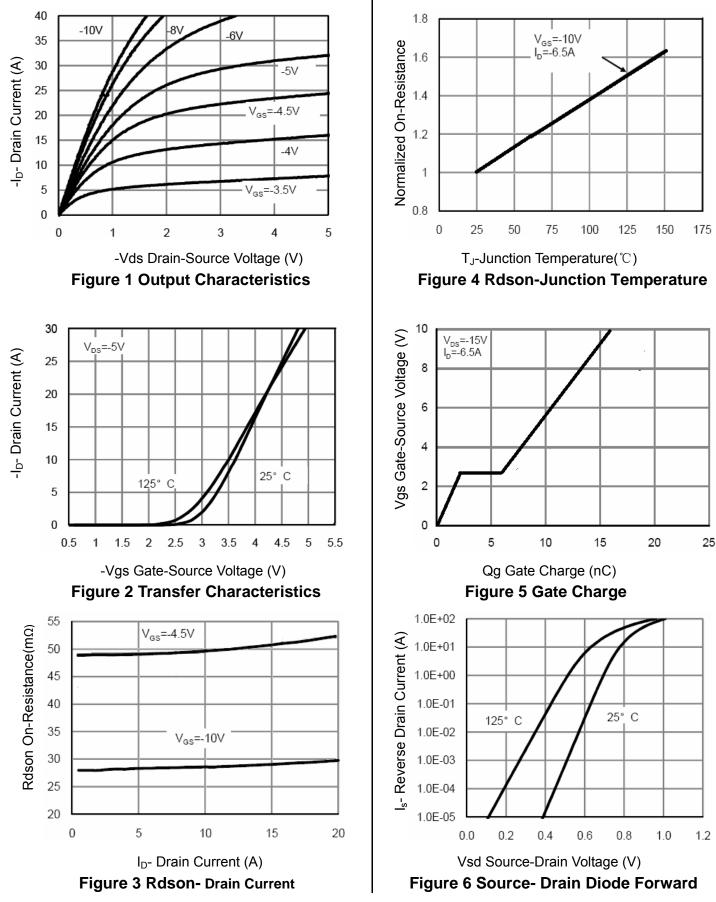
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Square Wave Pluse Duration(sec) Figure 13 Normalized Maximum Transient Thermal Impedance



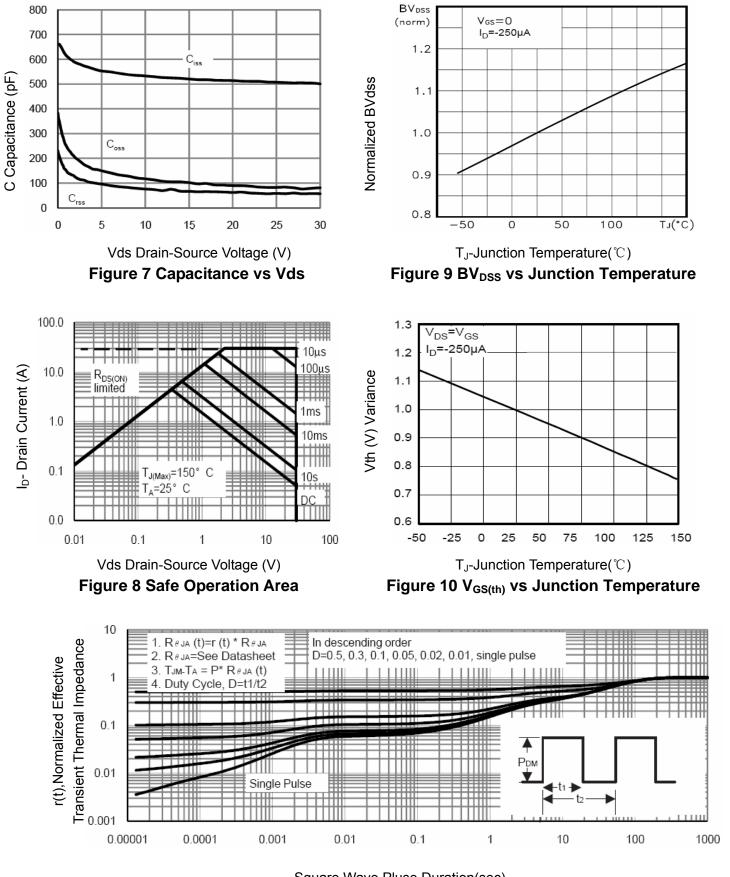
P- Channel Typical Electrical and Thermal Characteristics (Curves)





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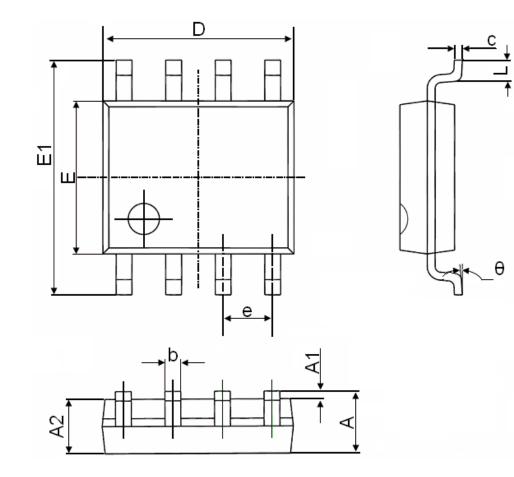
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Square Wave Pluse Duration(sec) Figure 11 Normalized Maximum Transient Thermal Impedance



SOP-8 Package Information



Symbol	Dimensions	n Millimeters	Dimensions In Inches		
	Min.	Max.	Min.	Max.	
A	1.350	1.750	0.053	0.069	
A1	0.100	0.250	0.004	0.010	
A2	1.350	1.550	0.053	0.061	
b	0.330	0.510	0.013	0.020	
С	0.170	0.250	0.006	0.010	
D	4.700	5.100	0.185	0.200	
E	3.800	4.000	0.150	0.157	
E1	5.800	6.200	0.228	0.244	
е	1.270	(BSC)	0.050(BSC)		
L	0.400	1.270	0.016	0.050	
θ	0°	8°	0°	8°	



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